IN THE UNITED STATES PATENT AND TRADEMARK OFFICE . In re the Application of:

Inventor: Masanori MINAMIO, et al. Prior Art Unit: 2815

Appln. No.: Divisional Appln. based Prior Examiner: L. C. Cruz

> On Appln. No. 09/380,312 filed August 31, 1999

Filed: December 31, 2003

RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A METHOD OF For:

MANUFACTURING THE SAME

## CONFIRMATION CLAIM FOR PRIORITY

Assistant Commissioner of Patents Washington, D.C. 20231

Sir:

The benefit of the filing date of the following foreign application filed in the following foreign country and priority provided in the 35 USC §119 have been claimed for the above-identified application:

> JAPANESE PATENT APPLICATION NO. 9-171395 FILED June 27, 1997 and

JAPANESE PATENT APPLICATION NO. 10-73711 FILED March 23, 1998.

The International Bureau received the priority document within the time limit in parent application serial no. 09/380,312 filed August 31, 1999.

It is requested that the file of this application be marked to indicate that the requirements of 35 USC §119 have been fulfilled and that the Patent and Trademark Office kindly acknowledge receipt of these papers.

Respectfully submitted,

James E. Ledbetter

Registration No. 28,732

Date: December 31, 2003

JEL/spp

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